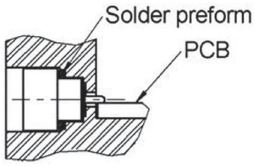
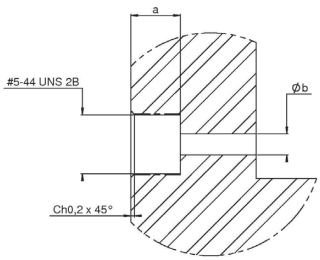
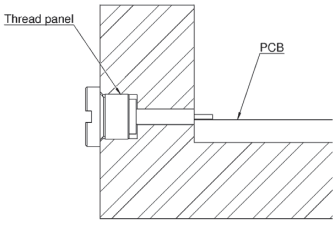
SMPM

PANEL DRILLING







1. Degrease and clean connector and box.
2. Solder the connector on the panel. We advise using SnAg4 Cu0.5 and a low residue flux.

   Preheating at 100°C is recommended. Take care not to exceed 260°C during soldering operation.
3. Solder the pin on the track. We advise using SnAg4 Cu0.5 and a low residue flux.

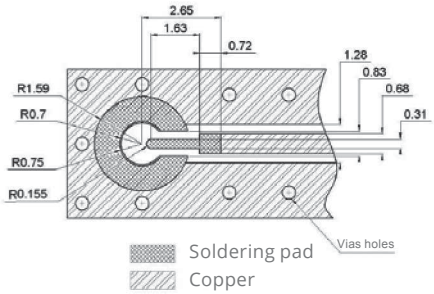
   Preheating at 100°C is recommended for ceramic substrate. Take care not to exceed 260°C during soldering operation.

	P03
A	5.31 - 5.33
B	1.09 - 1.12

1. Degrease and clean connector and box.
2. Screw-on the connector on the panel.
3. Solder the pin on the track.

ASSEMBLY INSTRUCTIONS

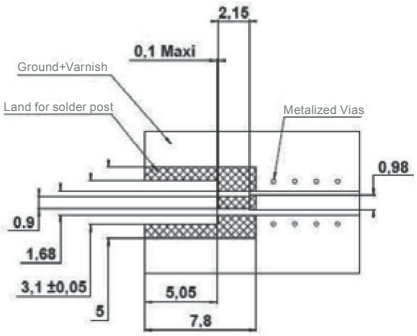
M01



CONNECTORS
R201 508 000
R201 508 700

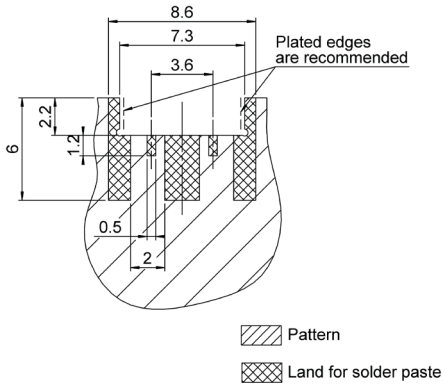
Valid for RT DUROID 5880 type PCB, thickness 0.254mm, with copper layer 35µm on both sides. Add between both sides along upper ground plane according to engineering practices.

M02



CONNECTORS
R201 423 110

M03



All dimensions are given in mm.